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**Chen et al.**

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(54) **REINFORCED MULTI-BODY OPTICAL DEVICES**

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*G02B 6/293* (2006.01)

(71) Applicant: **FINISAR CORPORATION**,  
Sunnyvale, CA (US)

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CPC ..... *G02B 27/283* (2013.01); *G02B 5/12*  
(2013.01); *G02B 6/29302* (2013.01); *G02B*  
*6/29386* (2013.01)

(72) Inventors: **Fan Chen**, Shanghai (CN); **Maofeng Gu**, Shanghai (CN); **Fahua Lan**, Shanghai (CN); **Huiping Li**, Shanghai (CN)

(58) **Field of Classification Search**  
USPC ..... 385/24  
See application file for complete search history.

(73) Assignee: **FINISAR CORPORATION**,  
Sunnyvale, CA (US)

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(\*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

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(21) Appl. No.: **14/557,244**

*Primary Examiner* — Uyen Chau N Le

*Assistant Examiner* — Hoang Tran

(22) Filed: **Dec. 1, 2014**

(74) *Attorney, Agent, or Firm* — Maschoff Brennan

(65) **Prior Publication Data**

US 2015/0083314 A1 Mar. 26, 2015

(57) **ABSTRACT**

Disclosed in one example embodiment is a method for fabricating a reinforced multi-body optical device. One method involves applying a coating to sides of an interior plate and bonding two plates to either side of the interior plate. The bonded plates are diced at an angle that is not orthogonal to the bonded plates. The top and bottom portions of a diced section are removed to form a multi-body polarization beam splitter (PBS) having a generally rectangular perimeter. A supporting plate is bonded to the multi-body PBS to form a reinforced multi-body PBS, wherein the supporting plate has a CTE that is within about 0.5 parts per million of the CTE of the multi-body PBS. The multi-body PBS is grinded to reduce the thickness of the multi-body PBS.

**Related U.S. Application Data**

(62) Division of application No. 12/941,284, filed on Nov. 8, 2010, now Pat. No. 8,903,206.

(30) **Foreign Application Priority Data**

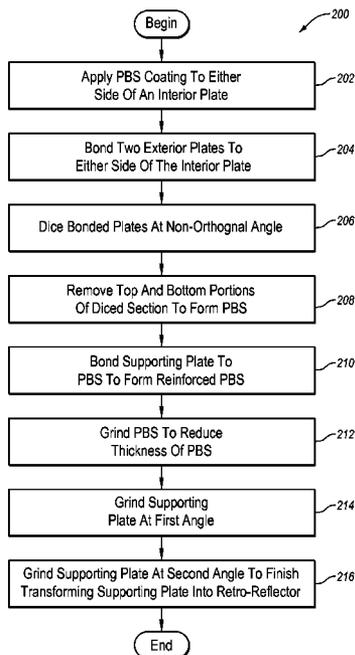
Feb. 8, 2010 (CN) ..... 2010 1 0112234

(51) **Int. Cl.**

*G02B 6/28* (2006.01)

*G02B 27/28* (2006.01)

**6 Claims, 14 Drawing Sheets**



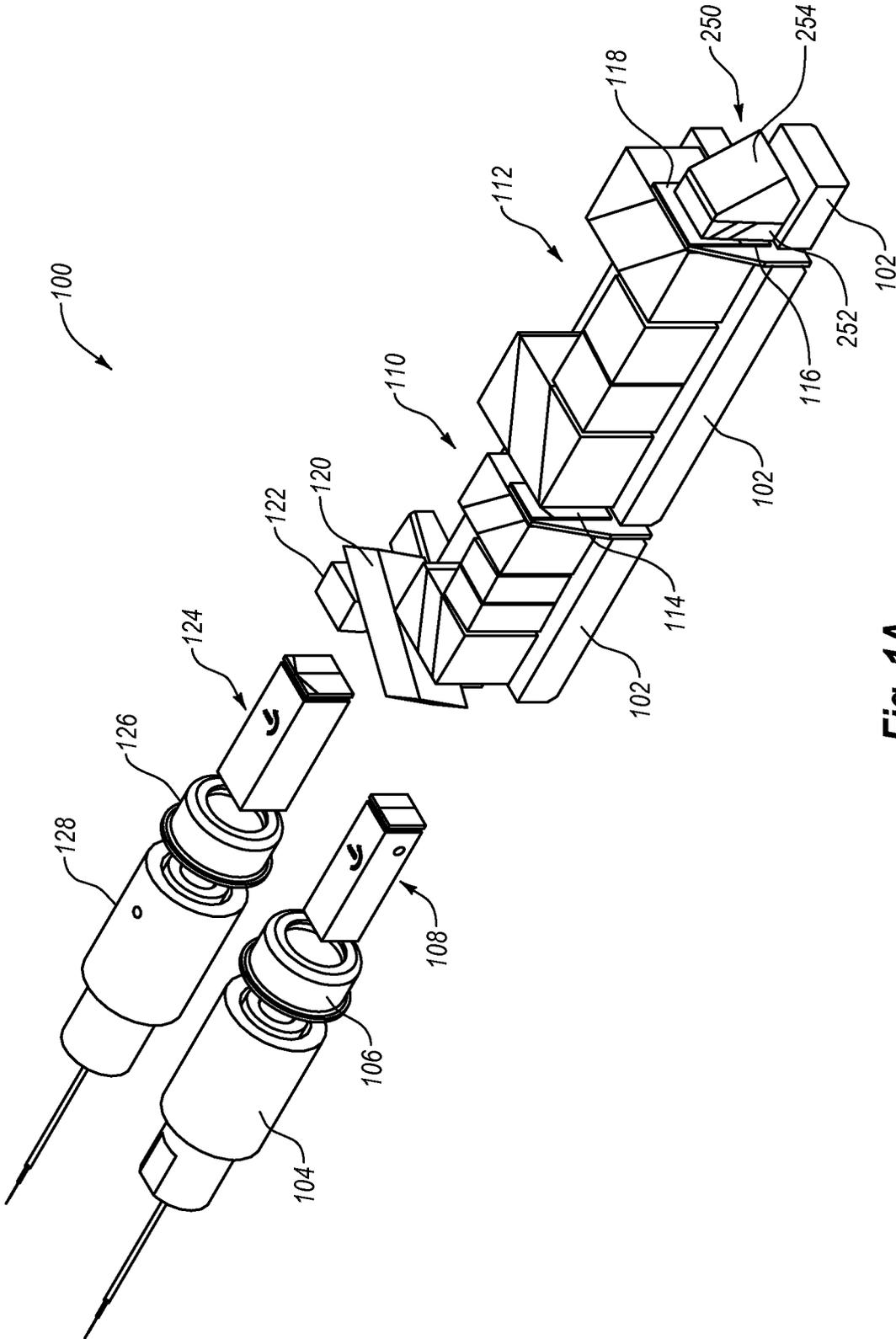
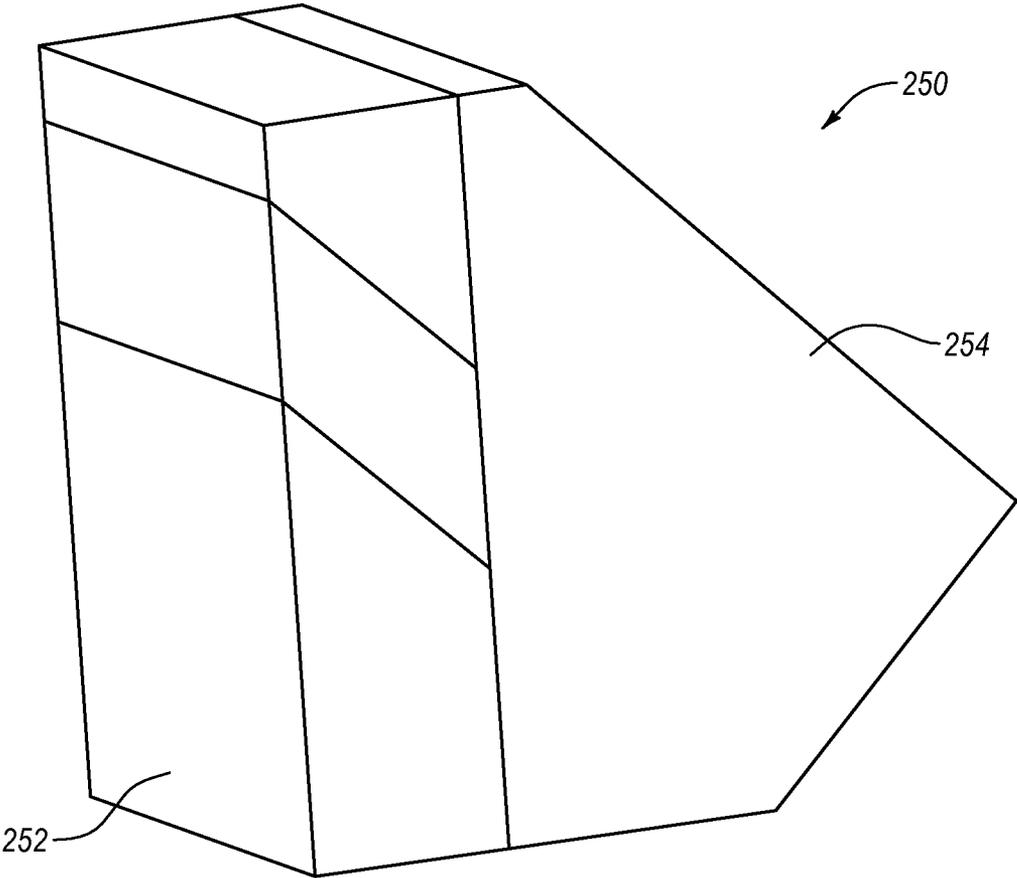
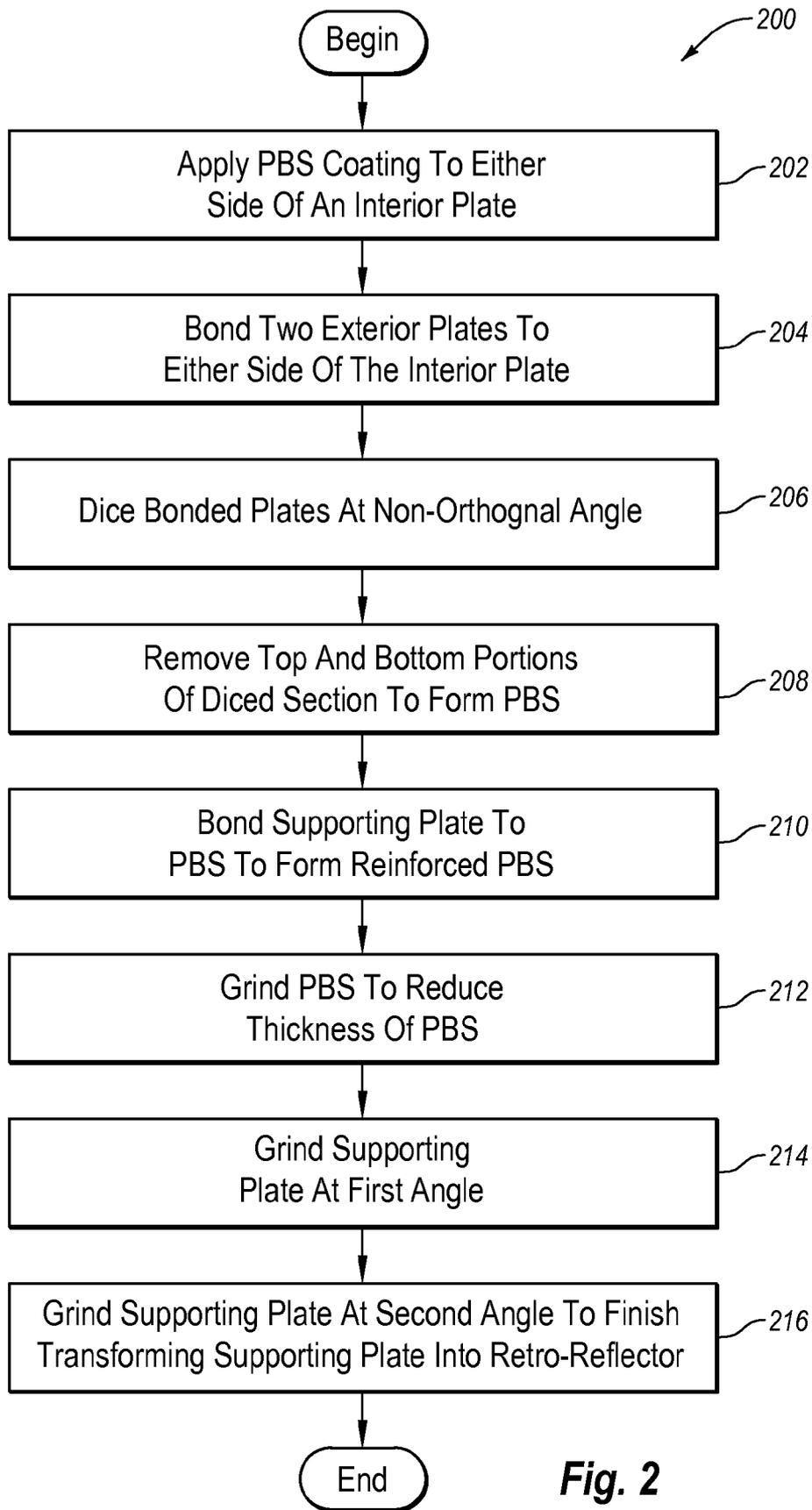


Fig. 1A



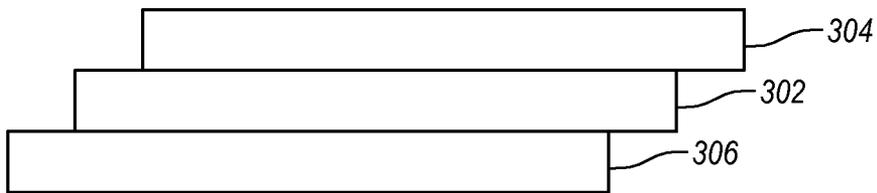
**Fig. 1B**



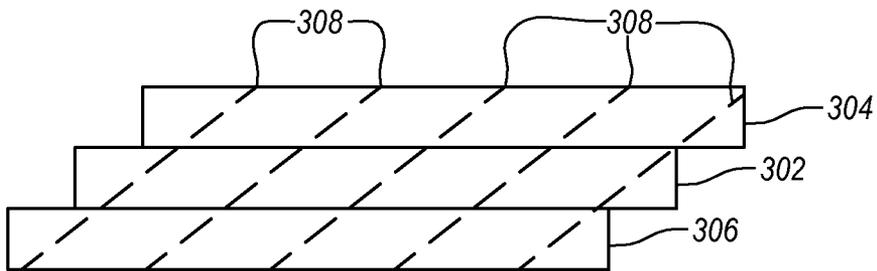
**Fig. 2**



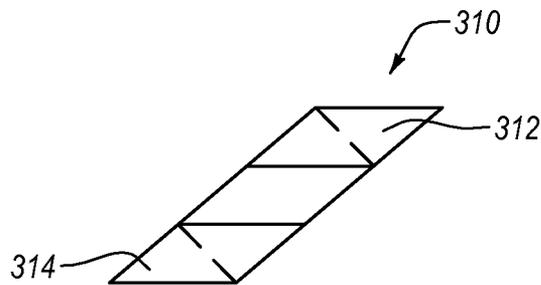
**Fig. 3A**



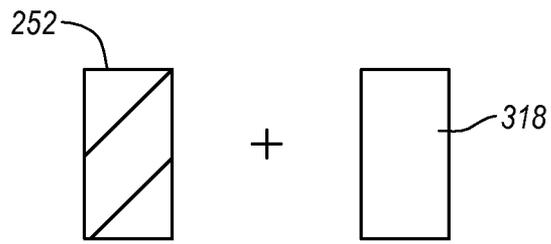
**Fig. 3B**



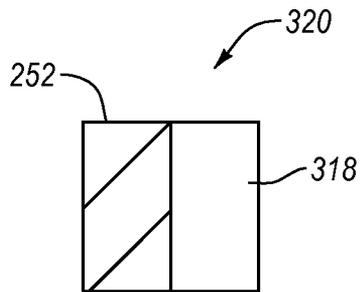
**Fig. 3C**



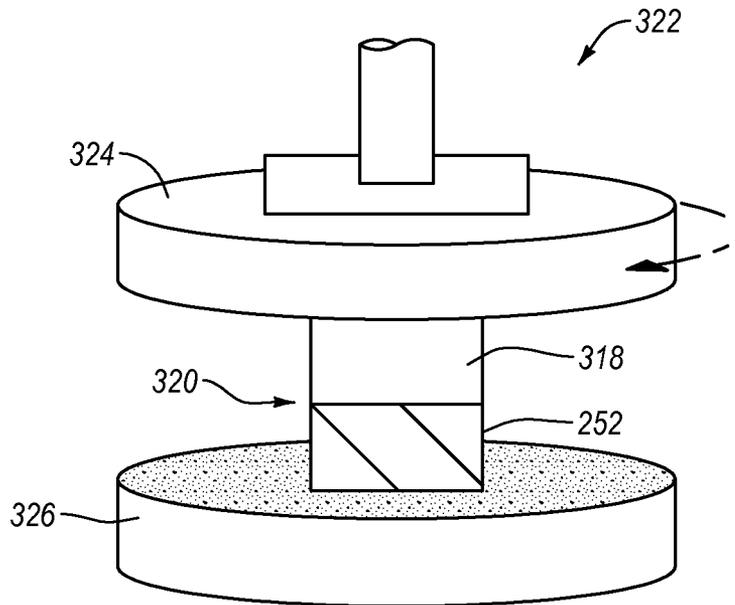
**Fig. 3D**



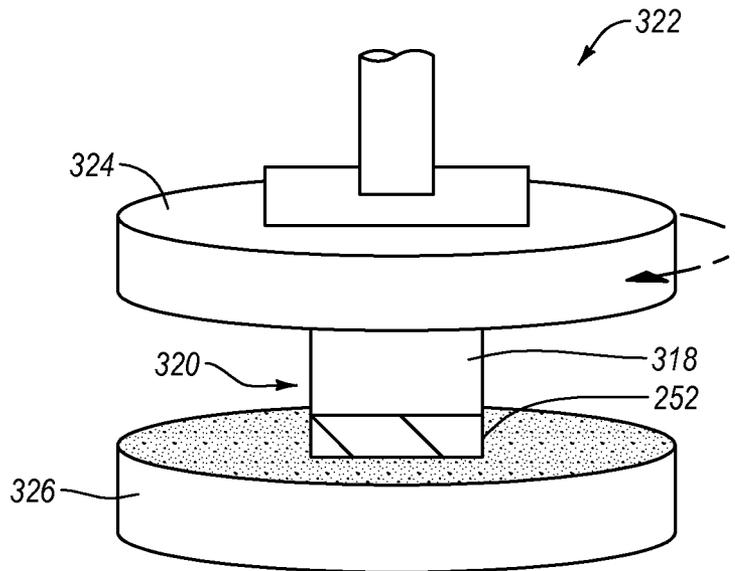
**Fig. 3E**



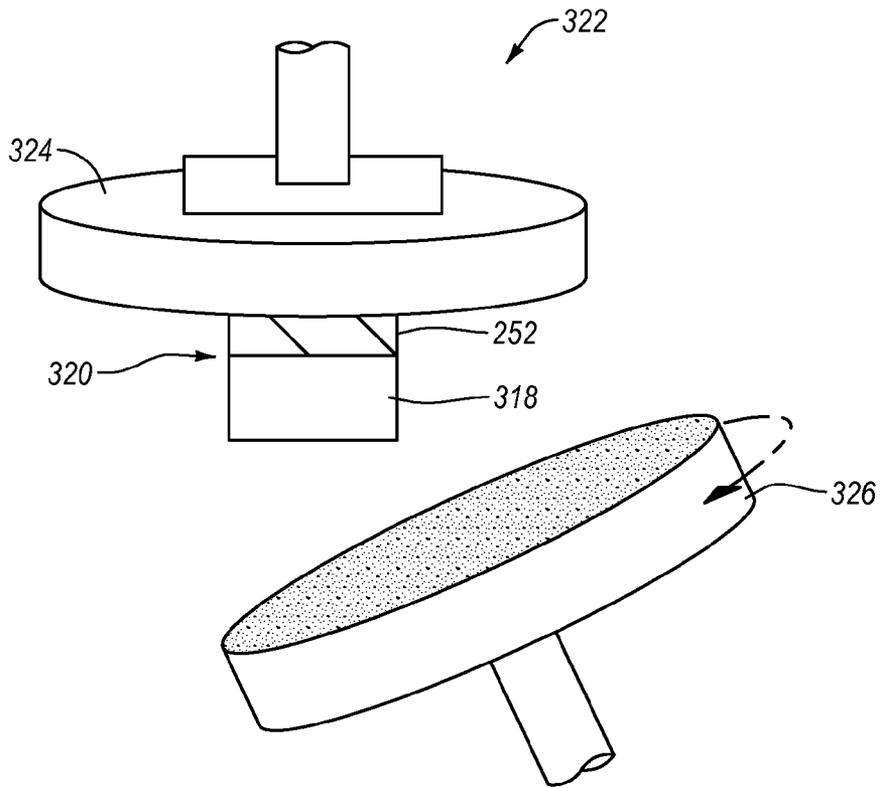
**Fig. 3F**



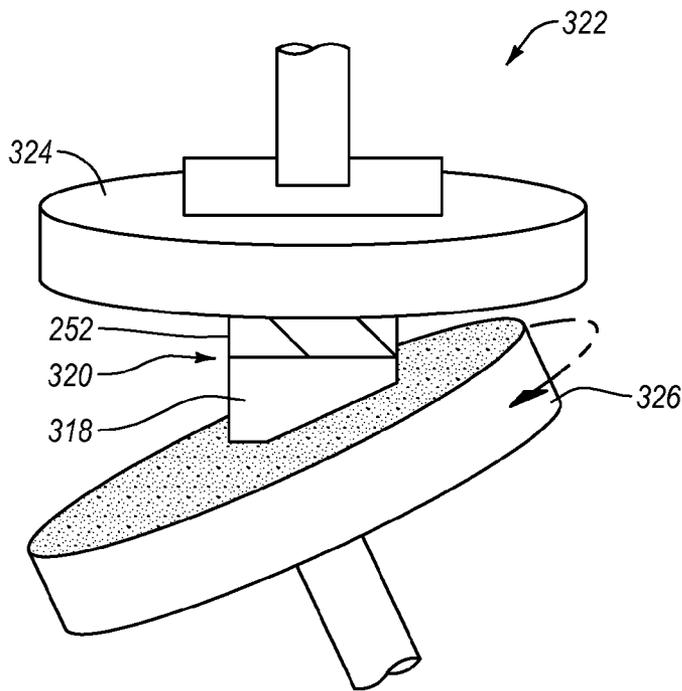
**Fig. 3G**



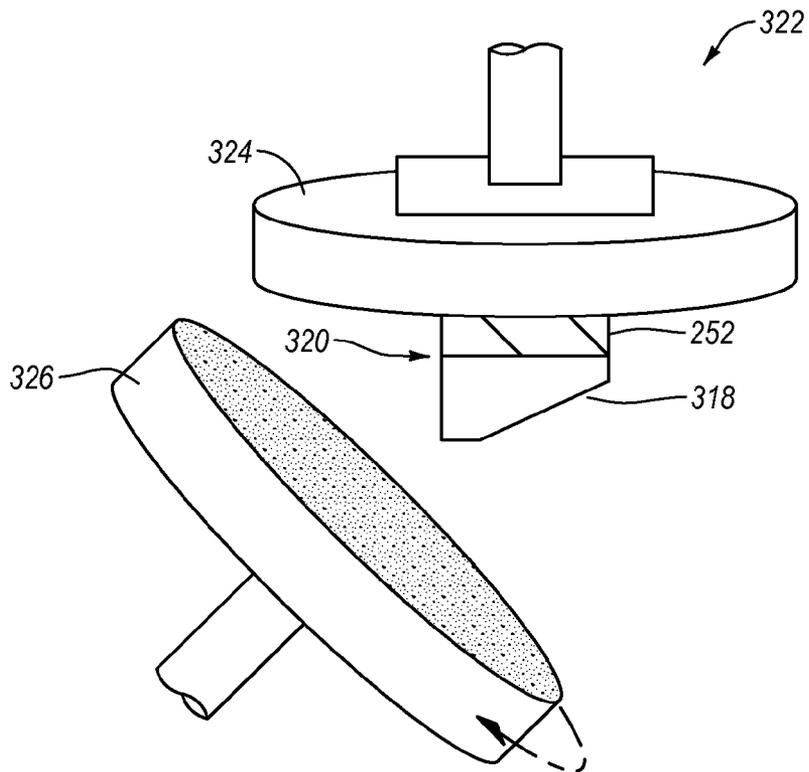
**Fig. 3H**



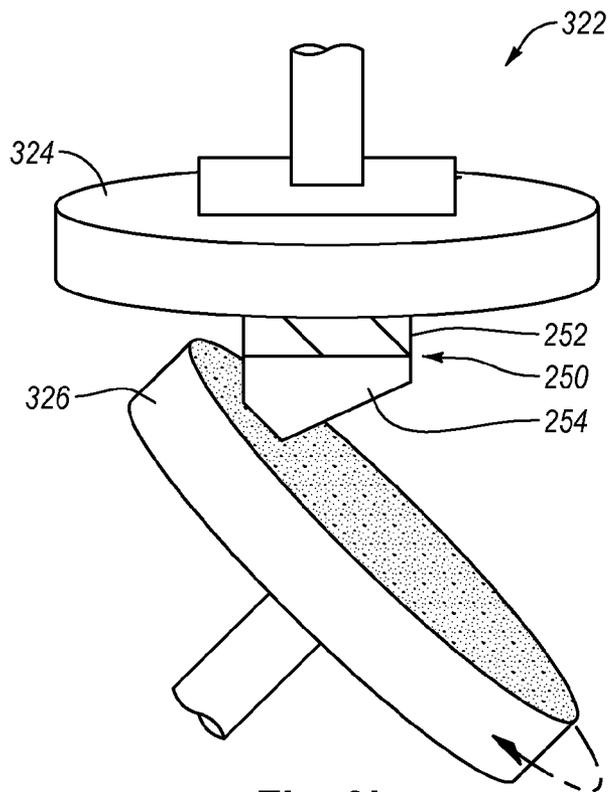
**Fig. 3I**



**Fig. 3J**



**Fig. 3K**



**Fig. 3L**

400

Optical Device	PBS Thickness (mm)	Gap Thickness (mm)	Retro Reflector Thickness (mm)	Overall Thickness (mm)	Insertion Loss (dB)	Extinct Ratio (dB)	Yield
Prior Art PBD	1	2	3	6	0.1	35	20%
PBD 250	1	0	3	4	0.05	35	90%

Fig. 4

500

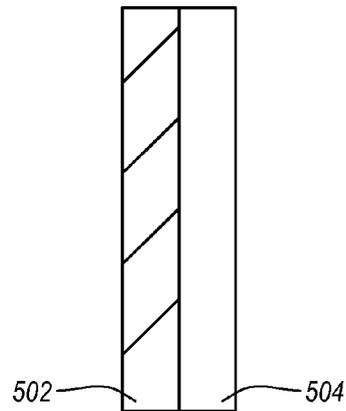
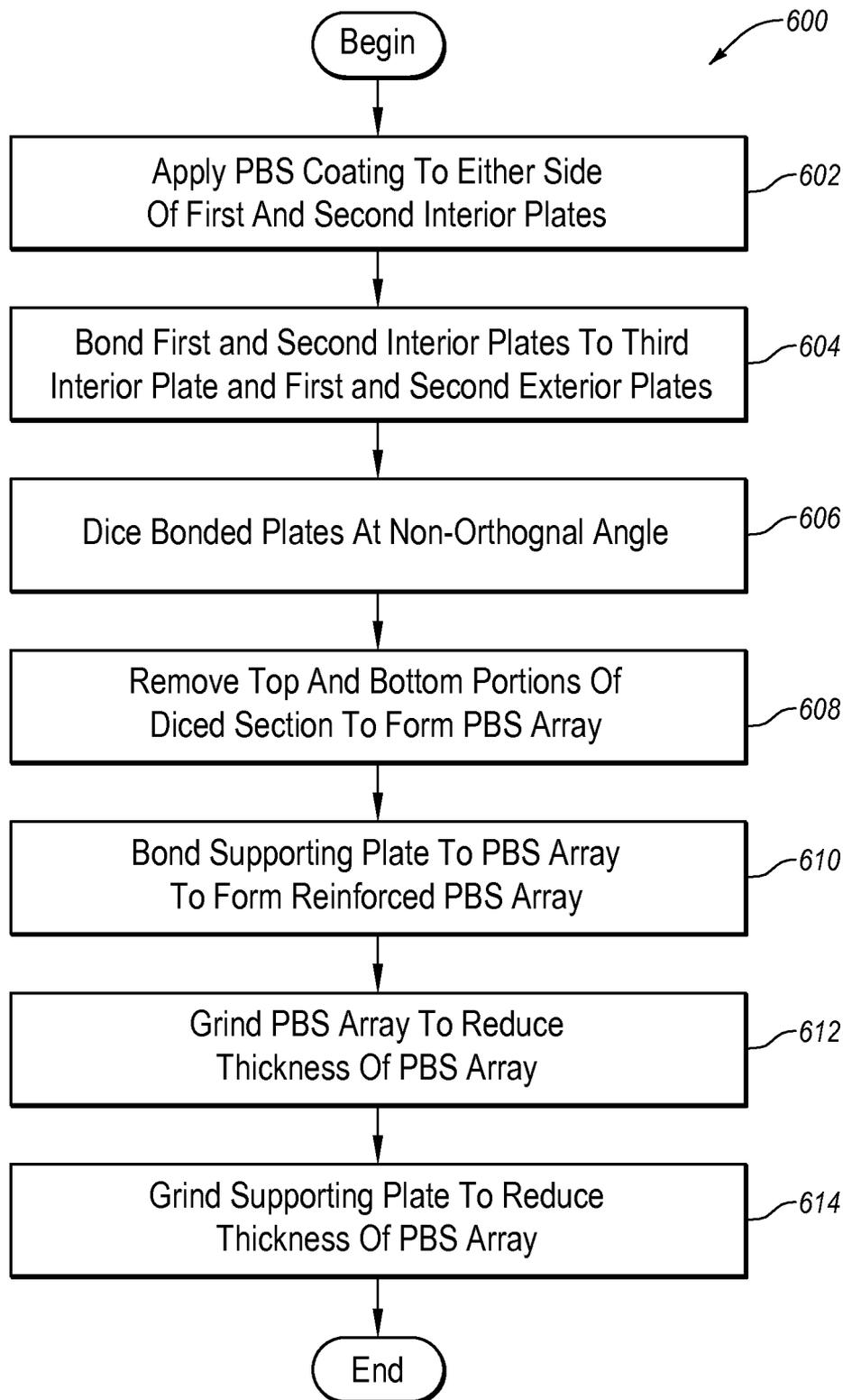
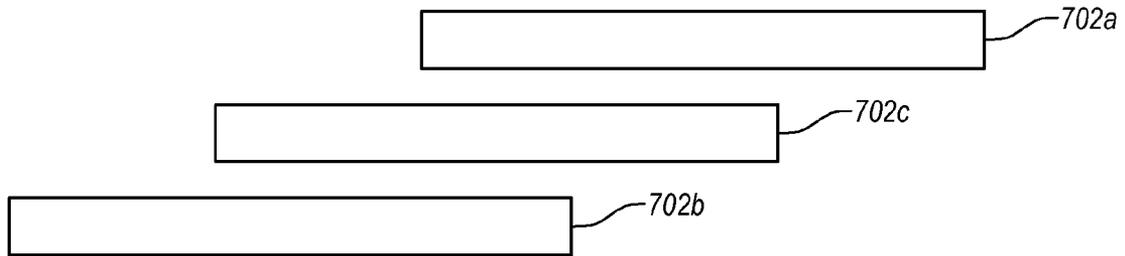


Fig. 5



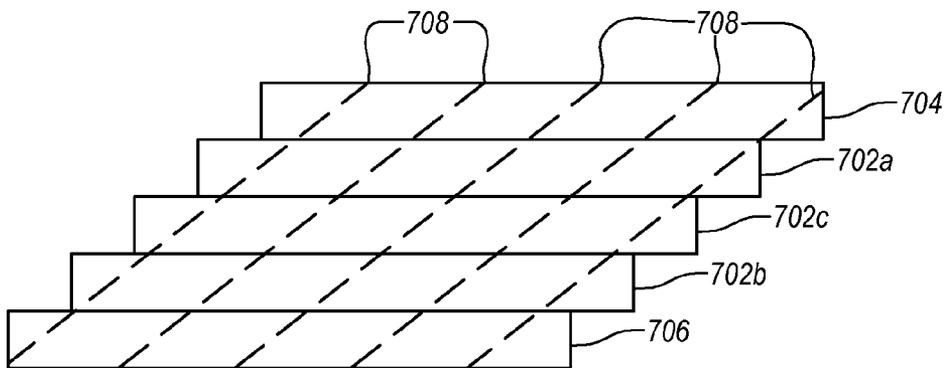
**Fig. 6**



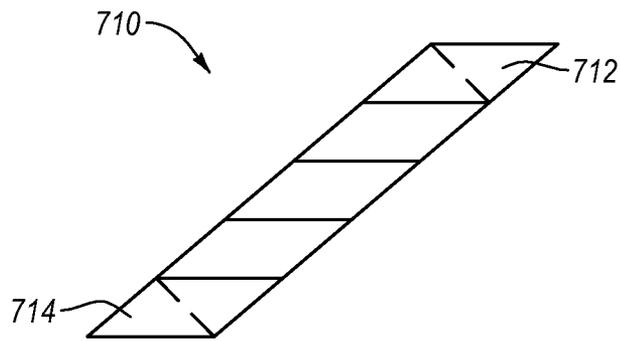
**Fig. 7A**



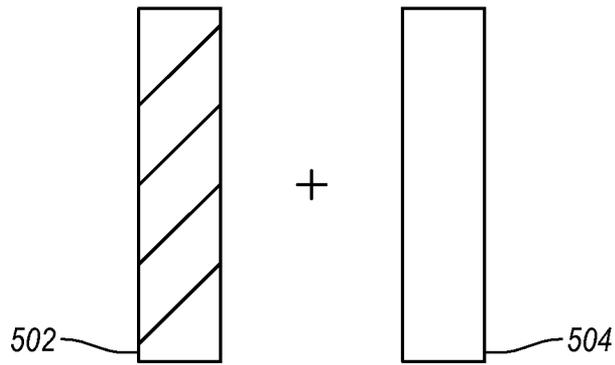
**Fig. 7B**



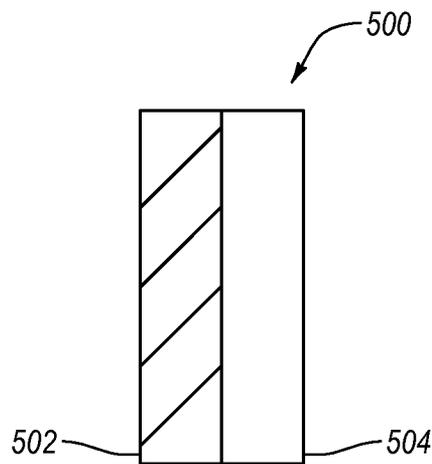
**Fig. 7C**



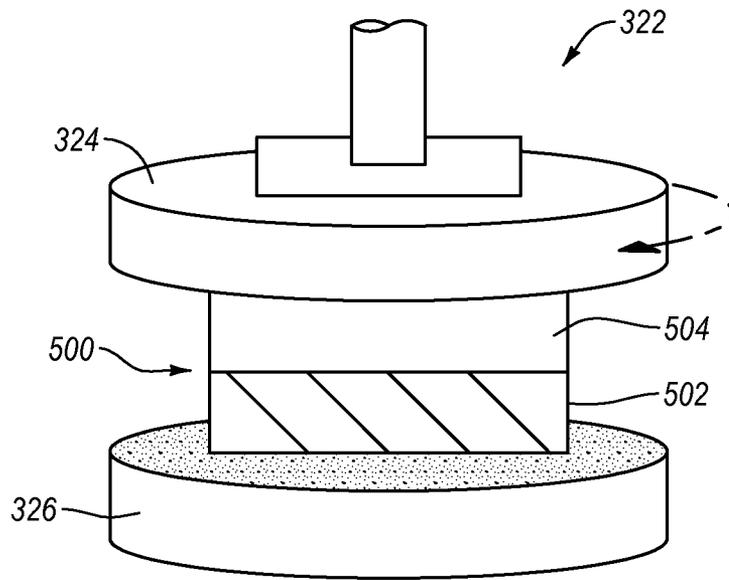
**Fig. 7D**



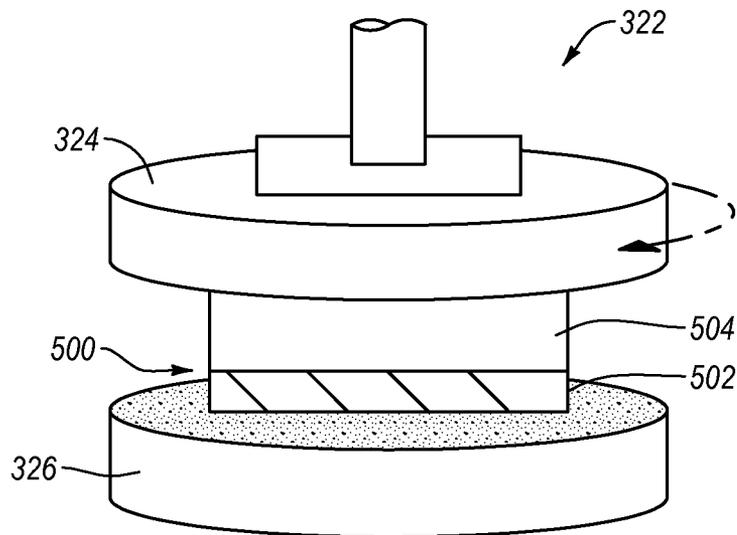
**Fig. 7E**



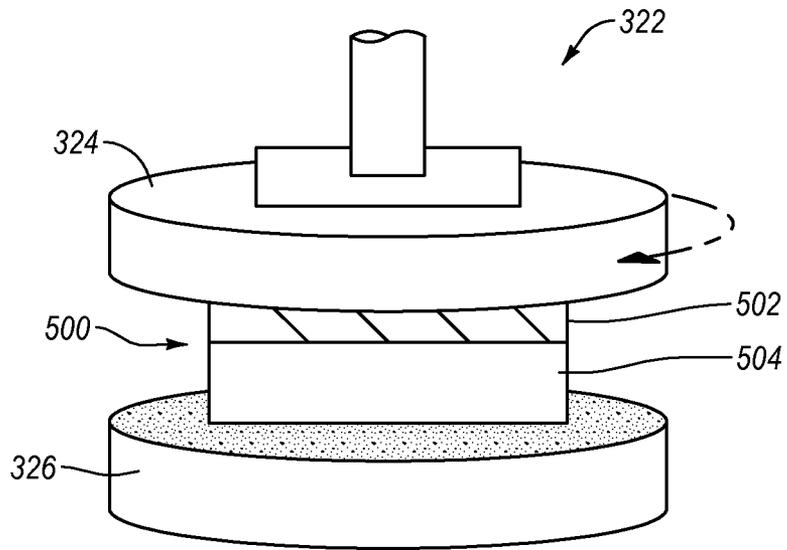
**Fig. 7F**



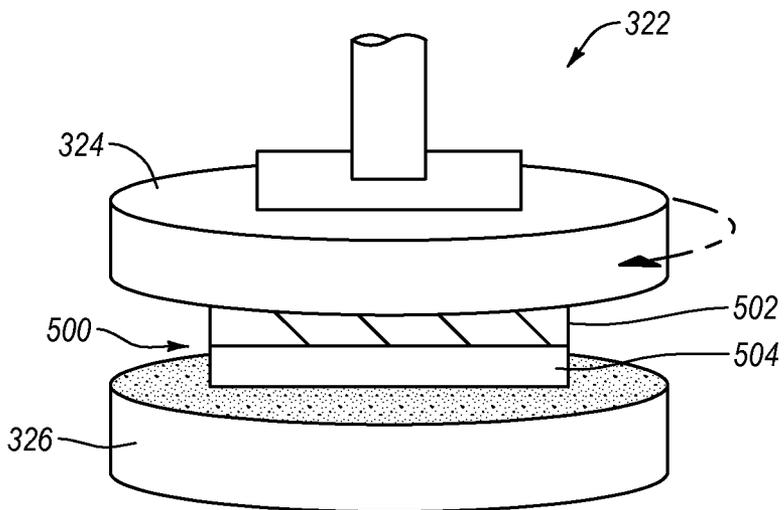
**Fig. 7G**



**Fig. 7H**



**Fig. 7I**



**Fig. 7J**

## REINFORCED MULTI-BODY OPTICAL DEVICES

### CROSS-REFERENCES AND RELATED APPLICATIONS

This application is a divisional of U.S. patent application Ser. No. 12/941,284 filed Nov. 8, 2010, titled REINFORCED MULTI-BODY OPTICAL DEVICES, which claims the benefit of Chinese Patent Application for Invention No. 201010112234.7, filed on Feb. 8, 2010, both of which are hereby incorporated by reference in their entireties.

### BACKGROUND

An optical interleaver is a passive fiber-optic device that is used to interleave two sets of dense wavelength-division multiplexing (DWDM) channels (odd and even channels) into a composite signal stream. For example, an optical interleaver can be configured to receive two multiplexed signals with 100 GHz spacing and interleave them to create a denser DWDM signal with channels spaced 50 GHz apart. An optical interleaver can also function as a deinterleaver by reversing the direction of the signal stream passing through the interleaver.

Optical interleavers have been widely used in DWDM systems and have become an important building block for optical networks with high-data-rate transmission. Optical interleavers are easier to manufacture in some respects compared to other bandpass filtering technologies, such as thin-film filters and arrayed waveguided gratings. However, with the increased demand for smaller and smaller optical interleavers, attempts have been made to also reduce the size of the internal components of the optical interleavers. However, as the sizes of the internal optical components are reduced, the process complexity of the fabrication of the internal components increases and the yield of internal components decreases.

### BRIEF SUMMARY OF SOME EXAMPLE EMBODIMENTS

In general, example embodiments of the invention relate to reinforced multi-body optical devices. At least some example embodiments enhance the strength of a multi-body optical device which enables the manufacture of a thinner multi-body optical device. The example embodiments disclosed herein also improve the long-term stability and reliability of these thinner multi-body optical device, even in harsh application environments.

In one example embodiment, a method for fabricating a reinforced multi-body optical device includes various acts. First, a supporting plate is bonded, using pressure and heat, to a multi-body optical device to form a reinforced multi-body optical device. The supporting plate has a coefficient of thermal expansion (CTE) that is within about 0.5 parts per million of the CTE of the multi-body optical device. Then, the multi-body optical device is ground to reduce the thickness of the multi-body optical device.

In another example embodiment, a method for fabricating a reinforced multi-body polarization beam splitter (PBS) includes various acts. First, a PBS coating is applied to either side of an interior plate. Next, two plates are bonded, using heat and pressure, to either side of the interior plate. Then, the bonded plates are diced at an angle that is not orthogonal to the bonded plates. Next, the top and bottom portions of a diced section are removed to complete the formation of a multi-body PBS having a generally rectangular perimeter.

Then, a supporting plate is bonded, using heat and pressure, to the multi-body PBS to form a reinforced multi-body PBS. The supporting plate has a CTE that is within about 0.5 parts per million of the CTE of the multi-body PBS. Finally, the multi-body PBS is ground to reduce the thickness of the multi-body PBS.

In yet another example embodiment, a reinforced multi-body optical device includes a multi-body optical device a supporting plate bonded without epoxy to the multi-body optical device. The multi-body optical device has a thickness that is less than or equal to about 1.0 millimeters. The supporting plate has a CTE that is within about 0.5 parts per million of the CTE of the multi-body optical device.

This Summary is provided to introduce a selection of concepts in a simplified form that are further described below in the Detailed Description. This Summary is not intended to identify key features or essential characteristics of the claimed subject matter, nor is it intended to be used as an aid in determining the scope of the claimed subject matter.

Additional features will be set forth in the description which follows, and in part will be obvious from the description, or may be learned by the practice of the teachings herein. Features of the invention may be realized and obtained by means of the instruments and combinations particularly pointed out in the appended claims. Features of the present invention will become more fully apparent from the following description and appended claims, or may be learned by the practice of the invention as set forth hereinafter.

### BRIEF DESCRIPTION OF THE DRAWINGS

To further clarify certain aspects of the present invention, a more particular description of the invention will be rendered by reference to example embodiments thereof which are disclosed in the appended drawings. It is appreciated that these drawings depict only example embodiments of the invention and are therefore not to be considered limiting of its scope. Aspects of the invention will be described and explained with additional specificity and detail through the use of the accompanying drawings in which:

FIG. 1A is a rear perspective view of an example optical deinterleaver having an example polarization beam displacer (PBD);

FIG. 1B is a perspective view of the example PBD of FIG. 1A;

FIG. 2 is a flowchart of an example method for fabricating the PBD of FIGS. 1A and 1B;

FIGS. 3A-3L are schematic views of various example embodiments of the acts of the example method of FIG. 2;

FIG. 4 is a chart comparing various characteristics of a prior art device and the example PBD of FIGS. 1A and 1B that was fabricated according to the example method of FIG. 2;

FIG. 5 is a side view of an example reinforced multi-body PBS array;

FIG. 6 is a flowchart of an example method for fabricating the reinforced multi-body PBS array of FIG. 5; and

FIGS. 7A-7J are schematic views of various example embodiments of the acts of the example method of FIG. 6.

### DETAILED DESCRIPTION OF SOME EXAMPLE EMBODIMENTS

Example embodiments of the present invention relate to reinforced optical devices. At least some example embodiments enhance the strength of an optical device which enables the manufacture of a thinner multi-body optical device. The example embodiments disclosed herein also improve the

long-term stability and reliability of these thinner multi-body optical device, even in harsh application environments.

Reference will now be made to the drawings to describe various aspects of example embodiments of the invention. It is to be understood that the drawings are diagrammatic and schematic representations of such example embodiments, and are not limiting of the present invention, nor are they necessarily drawn to scale.

Reference is first made to FIG. 1A in which an example interleaver 100 is disclosed. The example interleaver 100 is configured to interleave a first optical signal with a second optical signal and configured to deinterleave the first optical signal from the second optical signal. For example, the interleaved optical signal can have 50 GHz channel spacing, while the two deinterleaved optical signals can each have 100 GHz channel spacing.

As disclosed in FIG. 1A, the example interleaver 100 includes bases 102, a single-fiber collimator 104, a window cap 106, a first polarization beam displacing block 108, first and second filter cells 110 and 112 interleaved with a first half-waveplate 114, and a second half-waveplate 116. As disclosed in FIG. 1A, the example interleaver 100 also includes a third half-waveplate 118, a lateral shift prism 120, a roof prism 122, a second polarization beam displacing block 124, a window cap 126, and a dual fiber collimator 128. As disclosed in FIG. 1A, the example interleaver 100 further includes a combined polarization beam displacer 250.

As disclosed in FIG. 1B, the polarization beam displacer (PBD) 250 includes a polarization beam splitter (PBS) 252 and a retro-reflector 254. Unlike typical configurations in which the PBS is separated from the retro-reflector by an air gap, the PBS 252 is bonded directly to the retro-reflector 254 without any air gap. This direct bonding can avoid the need to coat the gap-facing sides of the PBS 252 and retro-reflector 254 with an anti-reflective coating, thus decreasing the cost and complexity of the PBS 252 and retro-reflector 254. This direct bonding also enables the retro-reflector 254 to reinforce the PBS 252, thus enabling the PBS 252 to be thinner than a stand-alone PBS, as discussed in greater detail below.

With reference now to FIG. 2, an example method 200 for fabricating the PBD 250 is disclosed. The acts of the example method 200 will now be discussed in connections with FIG. 3A-3I.

With reference to FIGS. 2 and 3A, the method 200 begins with an act 202 in which a coating, such as a PBS coating or other coating, is applied to either side of an interior plate 302. The interior plate 302 can be formed from a variety of optically transmissive materials including, but not limited to, silicon, plastics such as unfilled polyetherimide, fused silica, SF11 glass, and other glasses.

With reference to FIGS. 2 and 3B, the method 200 continues with an act 204 in which two exterior plates 304 and 306 are bonded, using heat and pressure, to either side of the interior plate 302. The exterior plates 304 and 306 can be formed from any of the materials listed above in connection with the interior plate 302. In at least some example embodiments, the exterior plates 304 and 306 are formed from the same material as the interior plate 302. The exterior plates 304 and 306 can be bonded to the interior plate 302 by first polishing the bonding surfaces. Then, the exterior plates 304 and 306 can be pressed against either side of the interior plate 302. Finally, the plates 302, 304, and 306 can be baked in an oven to complete the bonding process. For example, the plates 302, 304, and 306 can be baked in an oven at a temperature that is greater than or equal to 300 degrees Celsius. The baking at the act 204 can enable better molecular diffusion and adhesion between the bonded surfaces.

With reference to FIGS. 2, 3C, and 3D, the method 200 continues with an act 206 in which the bonded plates 302-306 are diced at an angle that is not orthogonal to the bonded plates 302-306. For example, the bonded plates 302-306 may be diced along the dotted lines 308, resulting in four diced sections similar to the diced section 310 disclosed in FIG. 3D.

With reference to FIGS. 2, 3D, and 3E, the method 200 continues with an act 208 in which a top portion 312 and a bottom portion 314 of a diced section 310 are removed to complete the formation of a multi-body PBS 252 having a generally rectangular perimeter.

With reference to FIGS. 2, 3E, and 3F, the method 200 continues with an act 210 in which a supporting plate 318 is bonded, using heat and pressure, to the PBS 252 to form a reinforced PBS 320. For example, the PBS 252 can be bonded to the supporting plate 318 using a technique similar to the technique discussed above in connection with the act 204. Also, the supporting plate can be formed from any of the materials listed above in connection with the interior plate 302. For example, the supporting plate 318 can be formed from the same material as the PBS 252. Alternatively, in at least some example embodiments, the material from which the supporting plate 318 is formed can have a coefficient of thermal expansion (CTE) that is within about 0.5 parts per million of the CTE of the material from which the PBS 252 is formed.

With reference to FIGS. 2, 3G, and 3H, the method 200 continues with an act 212 in which the PBS 252 is ground to reduce the thickness of the PBS 252. As disclosed in FIG. 3G, this grinding can be accomplished using a grinder 322 that includes a mount 324 and a grinding plate 326. The supporting plate 318 of the reinforced PBS 320 can be mounted to the mount 324 and the grinder 322 can then cause the mount 324 and the reinforced PBS 320 to rotate with respect to the grinding plate 326. The friction between the grinding plate 326 and the PBS 252 of the reinforced PBS 320 causes a portion of the PBS 252 to be ground away, resulting in a reduction of the thickness of the PBS 252, as disclosed in FIG. 3H. The thickness of the PBS 252 can be reduced to about 1.0 millimeter or less. For example, the thickness of the PBS 252 can be reduced to about 0.3 millimeters or less. The grinding plate 326 can be a tar polishing plate, for example, although other types of grinding plates are possible and contemplated.

With reference to FIGS. 2, 3I, and 3J, the method 200 continues with an act 214 in which a first portion of the supporting plate 318 is ground at a first angle. As disclosed in FIGS. 3I and 3J, this grinding can be accomplished using the grinder 322. As disclosed in FIG. 3I, the PBS 252 of the reinforced PBS 320 can be mounted to the mount 324 at a first angle to the grinding plate 326. The grinder 322 can then cause the grinding plate 326 to rotate with respect to the mount 324 and the reinforced PBS 320. The friction between the grinding plate 326 and the supporting plate 318 causes a corner of the supporting plate 318 to be ground away, resulting in a first angled surface on the supporting plate 318, as disclosed in FIG. 3J.

With reference to FIGS. 2, 3K, and 3L, the method 200 continues with an act 216 in which a second portion of the supporting plate 318 is ground at a second angle. As disclosed in FIG. 3K and 3J, this grinding can be accomplished using the grinder 322. As disclosed in FIG. 3K, the PBS 252 of the reinforced PBS 320 can be mounted to the mount 324 at a first angle to the grinding plate 326. The grinder 322 can then cause the grinding plate 326 to rotate with respect to the mount 324 and the reinforced PBS 320. The friction between the grinding plate 326 and the supporting plate 318 causes a second corner of the supporting plate 318 to be ground away,

resulting in a second angled surface on the supporting plate **318**, as disclosed in FIG. **3L**. Thus, the acts **214** and **216** transform the supporting plate **318** into the retro-reflector **254** and transform the reinforced PBS **320** into the PBD **250**.

With reference to FIG. **4**, a chart **400** compares a prior art PBD with the PBD **250**. The prior art PBD includes a PBS and a retro-reflector separated by a 2 millimeter gap. As disclosed in the chart **400**, the thickness of the PBS in both optical devices is about 1 millimeter and the thickness of the retro-reflector in both optical device is about 3 millimeters. However, the PBS and the retro-reflector of the prior art PBD is separated by a 2 millimeter gap, while the PBS **252** and the retro-reflector **254** of the PBD **250** are not separated by a gap and are instead bonding directly to one another. Accordingly, the overall thickness of the prior art PBD is about 2 millimeters thicker than the overall thickness of the PBD **250**.

Further, the bond-facing surfaces of the PBS and the retro-reflector of the prior art PBD are also coated with an anti-reflective coating, while the PBS **252** and the retro-reflector **254** of the PBD **250** include no such anti-reflective coating. Thus, the removal of the anti-reflective coating from the PBD **250** decreases the cost and complexity of manufacturing the PBD **250**.

As disclosed in the chart **400**, the yield of the PBD **250** is about 90 percent, while the yield of the prior art PBD is only about 20 percent. In addition, the insertion loss of the PBD **250** is about half the insertion loss of the prior art PBD, while the extinction ratio remains about equal between the two optical devices. Thus, the PBD **250** exhibits a dramatic increase in the yield and a dramatic decrease in the insertion loss over the prior art PBD. Further, the PBD **250** can be manufactured with a decreased fabrication complexity and result exhibit less thermal deformation than the prior art PBD.

With reference now to FIG. **5**, another type of optical device is disclosed. In particular, FIG. **5** discloses a reinforced polarization beam splitter array (PBS array) **500**. The reinforced PBS array **500** includes a PBS array **502** and a supporting plate **504**. The PBS array **502** is bonded directly to the supporting plate **504**. This direct bonding enables the supporting plate **504** to reinforce the PBS array **502**, thus enabling the PBS array **502** to be thinner than a stand-alone PBS array, as discussed in greater detail below. Like the PBS **252** of FIGS. **1A** and **1B**, the PBS array **502** is a multi-body optical device. However, instead of being formed from only three components, the PBS array **502** is formed from five components.

With reference now to FIG. **6**, an example method **600** for fabricating the reinforced PBS array **500** is disclosed. The acts of the example method **600** will now be discussed in connections with FIG. **7A-7I**.

With reference to FIGS. **6** and **7A**, the method **600** begins with an act **602** in which a coating, such as a PBS coating or other coating, is applied to either side of first and second interior plates **702a** and **702b**. The interior plates **702a** and **702b** can be formed from a variety of optically transmissive materials including, but not limited to, any of the materials listed above in connection with the interior plate **302**.

With reference to FIGS. **2** and **3B**, the method **200** continues with an act **604** in which the first and second interior plates **702a** and **702b** are bonded to either side of a third interior plates **702c** and two exterior plates **704** and **706** are bonded to the interior plates **702a** and **702b**, using heat and pressure. The exterior plates **704** and **706** can be formed from any of the materials listed above in connection with the interior plate **302**. In at least some example embodiments, the exterior plates **704** and **706** are formed from the same material as the interior plate **702**. The plates **704**, **702a**, **702c**, **702b**,

and **706** can be bonded to one another by polishing the bonding surfaces, pressing the plates against one another, and baking the plates in an oven at a temperature that is greater than or equal to 300 degrees Celsius, for example.

With reference to FIGS. **6**, **7C**, and **7D**, the method **600** continues with an act **606** in which the bonded plates **704**, **702a**, **702c**, **702b**, and **706** are diced at an angle that is not orthogonal to the bonded plates. For example, the bonded plates **704**, **702a**, **702c**, **702b**, and **706** may be diced along the dotted lines **708**, resulting in four diced sections similar to the diced section **710** disclosed in FIG. **7D**.

With reference to FIGS. **6**, **7D**, and **7E**, the method **600** continues with an act **608** in which a top portion **712** and a bottom portion **714** of a diced section **710** are removed to complete the formation of a multi-body PBS array **502** having a generally rectangular perimeter.

With reference to FIGS. **6**, **7E**, and **7F**, the method **600** continues with an act **610** in which a supporting plate **504** is bonded, using heat and pressure, to the PBS array **502** to form the reinforced PBS array **500**. For example, the PBS array **502** can be bonded to the supporting plate **504** using a technique similar to the technique discussed above in connection with the act **604**. Also, the supporting plate can be formed from any of the materials listed above in connection with the plates **704**, **702a**, **702c**, **702b**, and **706**. For example the supporting plate **504** can be formed from the same material as the PBS array **502**. Alternatively, in at least some example embodiments, the material from which the supporting plate **504** is formed can have a CTE that is within about 0.5 parts per million of the CTE of the material from which the PBS array **502** is formed.

With reference to FIGS. **6**, **7G**, and **7H**, the method **600** continues with an act **612** in which the PBS array **502** is ground to reduce the thickness of the PBS array **502**. As disclosed in FIG. **7G**, this grinding can be accomplished using the grinder **322**, which is discussed above in connection with FIGS. **3A-3L**. The supporting plate **504** of the reinforced PBS array **500** can be mounted to the mount **324** and the grinder **322** can then cause the mount **324** and the reinforced PBS array **500** to rotate with respect to the grinding plate **326**. The friction between the grinding plate **326** and the PBS array **502** of the reinforced PBS array **500** causes a portion of the PBS array **502** to be ground away, resulting in a reduction of the thickness of the PBS array **502**, as disclosed in FIG. **7H**. The thickness of the PBS array **502** can be reduced to about 1.0 millimeter or less. For example, the thickness of the PBS array **502** can be reduced to about 0.3 millimeters or less.

With reference to FIGS. **6**, **7I**, and **7J**, the method **600** continues with an act **614** in which the supporting plate **504** is ground to reduce the thickness of the supporting plate **504**. As disclosed in FIG. **7I**, this grinding can be accomplished using the grinder **322**. The PBS array **502** of the reinforced PBS array **500** can be mounted to the mount **324** and the grinder **322** can then cause the grinding plate **326** to rotate with respect to the mount **324** and the reinforced PBS array **500**. The friction between the grinding plate **326** and the supporting plate **504** of the reinforced PBS array **500** causes a portion of the supporting plate **504** to be ground away, resulting in a reduction of the thickness of the supporting plate **504**, as disclosed in FIG. **7J**. The thickness of the supporting plate **504** can be reduced to about 1.0 millimeter or less. For example, the thickness of the supporting plate **504** can be reduced to about 0.3 millimeters or less.

Similar to the PBD **250**, the reinforced multi-body PBS array **500** can be manufactured with a higher yield than prior art PBS arrays. Further, the bonding of the supporting layer **504** to the multi-body PBS array **502** reduces the thermal deformation of the multi-body PBS array **502**. The method

600 also decreased the fabrication complexity, the thickness, and the insertion loss of the reinforced multi-body PBS array 500.

The example embodiments disclosed herein may be embodied in other specific forms. The example embodiments disclosed herein are to be considered in all respects only as illustrative and not restrictive.

What is claimed is:

1. A method for fabricating a reinforced multi-body optical device, the method comprising:  
 10 applying a coating to either side of an interior plate;  
 a first bonding, using heat and pressure, bonding two plates to either side of the interior plate;  
 15 dicing the bonded plates at an angle that is not orthogonal to the bonded plates;  
 removing top and bottom portions of a diced section to form a multi-body polarization beam splitter (PBS) having a generally rectangular perimeter;  
 20 a second bonding, using heat and pressure, bonding a supporting plate to the multi-body PBS to form a reinforced multi-body PBS, wherein the supporting plate has a CTE that is within about 0.5 parts per million of the CTE of the multi-body PBS; and  
 25 grinding the multi-body PBS to reduce the thickness of the multi-body PBS.

2. The method as recited in claim 1, further comprising: grinding the supporting plate to reduce the thickness of the supporting plate.  
 3. The method as recited in claim 2, wherein the thickness of the reinforced multi-body PBS is less than or equal to about 1.0 millimeters.  
 4. The method as recited in claim 1, further comprising: grinding a first portion of the supporting plate a first angle; and grinding a second portion of the supporting plate at a second angle, so as to transform the supporting plate into a retro-reflector and transform the reinforced multi-body PBS into a PBD.  
 5. The method as recited in claim 1, wherein the second bonding comprises:  
 polishing a surface of the multi-body PBS;  
 polishing a surface of the supporting plate;  
 pressing the polished surface of the multi-body PBS against the polished surface of the supporting plate to form the reinforced multi-body PBS; and  
 baking the reinforced multi-body PBS in an oven at a temperature that is greater than or equal to about 300° Celsius.  
 6. The method as recited in claim 1, wherein the grinding comprises grinding the multi-body PBS to reduce the thickness of the multi-body PBS using a tar polishing plate.

\* \* \* \* \*

UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 9,097,908 B2  
APPLICATION NO. : 14/557244  
DATED : August 4, 2015  
INVENTOR(S) : Chen et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Specification

In Column 1, Line 8, delete “2010,” and insert -- 2010, now Pat. No. 8,903,206, --, therefor.

In Column 6, Lines 65-66, delete “layer 504” and insert -- plate 504 --, therefor.

Claims

In Column 8, Line 8, in Claim 4, delete “plate a” and insert -- plate at a --, therefor.

Signed and Sealed this  
Fifth Day of July, 2016



Michelle K. Lee  
*Director of the United States Patent and Trademark Office*